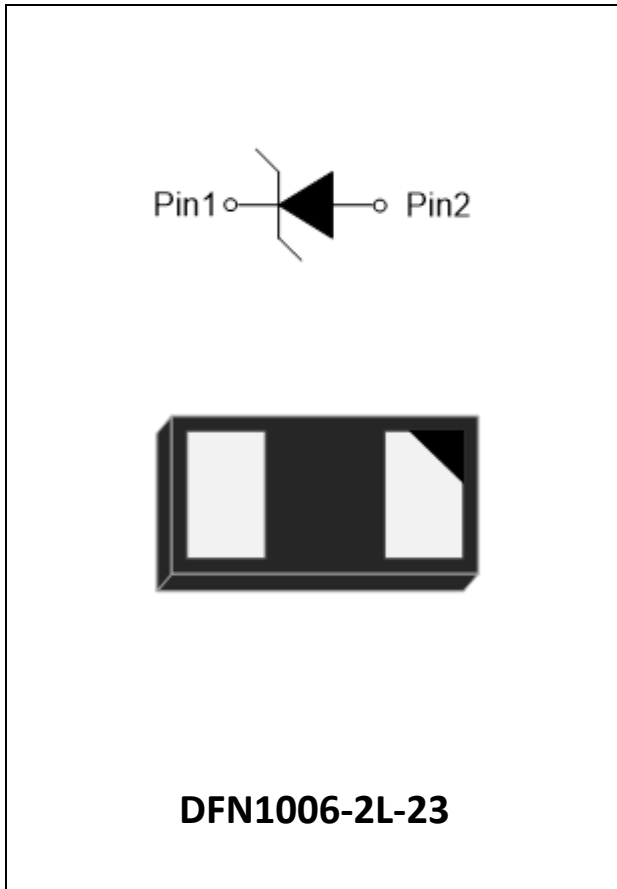


1- Line, Uni-directional, Transient Voltage Suppressor



Features

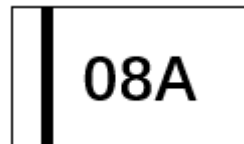
- Stand-off voltage: 8V Max
- Transient protection for each line according to
IEC61000-4-2(ESD): $\pm 30\text{kV}$ (contact)
IEC61000-4-5(surge): 26A (8/20 μs)
- Low leakage current
- Low clamping voltage
- Low clamping voltage:
 $V_{CL} = 8.8\text{V typ. @ IPP} = 16\text{A (TLP)}$
- RoHS Compliant

Applications

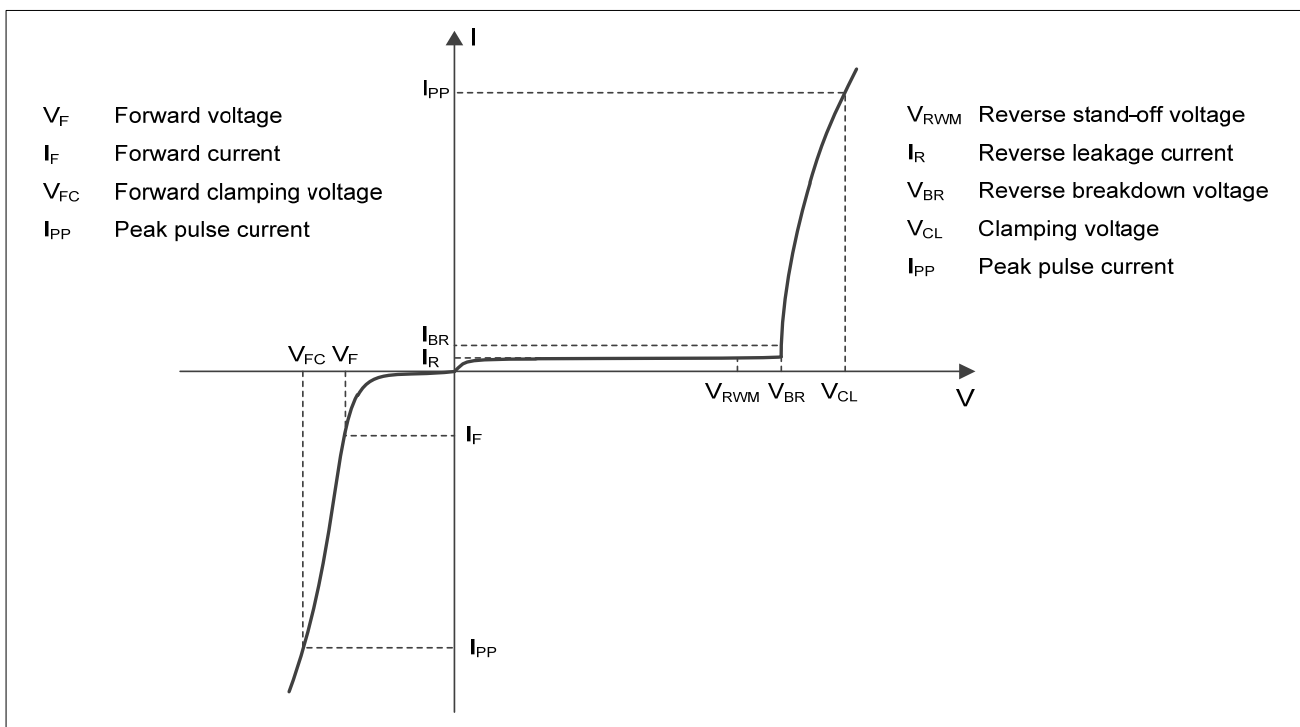
- Power supply protection
- Power management

Mechanical Data

- Package: DFN1006-2L
- Case Material: "Green" Molding Compound
- Marking Information: See Below



■Definitions of electrical characteristics





ESD8V0LA2

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	422	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{PP}	26	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 30	KV
ESD according to IEC61000-4-2 contact discharge		± 8	
Junction temperature	T_J	125	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

■Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				8
Reverse leakage current	I_R	μA	$V_{RWM} = 8V,$			1
Reverse breakdown voltage	$V_{(BR)}$	V	$I_T = 1mA,$	8		10
Clamping voltage	V_{CL}	V	$I_{PP} = 1A, t_p = 8/20\mu s$			13
		V	$I_{PP} = 26A, t_p = 8/20\mu s$			17
Junction capacitance	CJ	pF	$V_R = 0V, f = 1MHz$		195	

Notes:

- (1). TLP parameter: $Z_0 = 50\Omega, t_p = 100ns, t_r = 2ns,$ averaging window from 60ns to 80ns. RDYN is calculated from 4A to 16A.
- (2). Contact discharge mode, according to IEC61000-4-2.
- (3). Non-repetitive current pulse, according to IEC61000-4-5

■Ordering Information (Example)

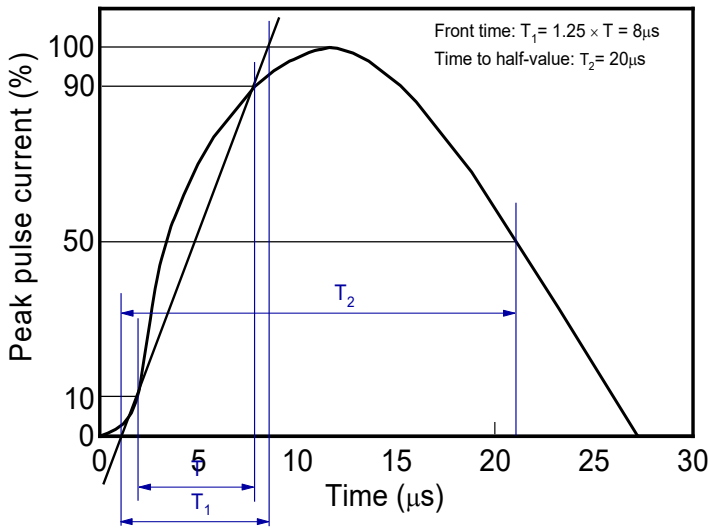
PREFERED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESD8V0LA2	F1	Approximate 0.9	10000	100000	400000	7 reel



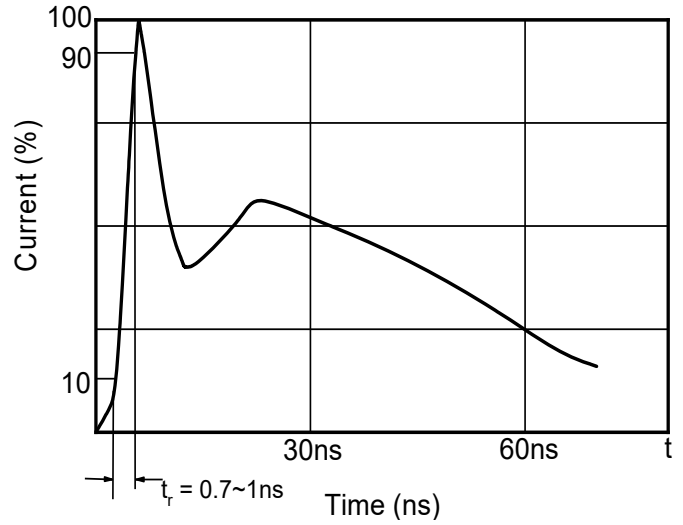
ESD8V0LA2

■ Characteristics (Typical)

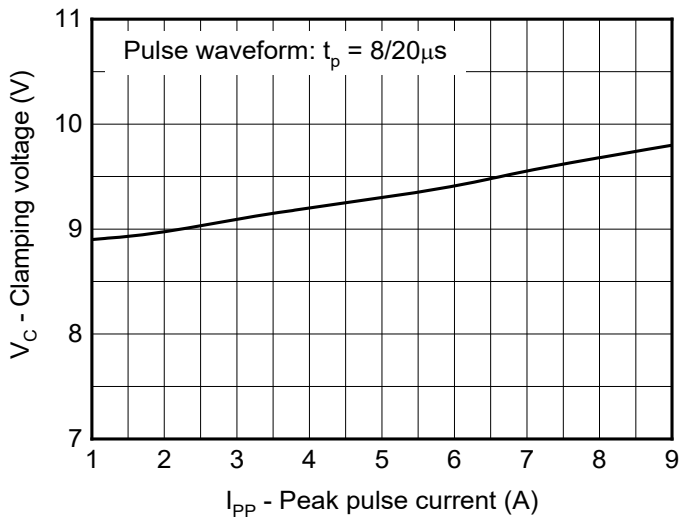
8/20 μ s waveform per IEC61000-4-5



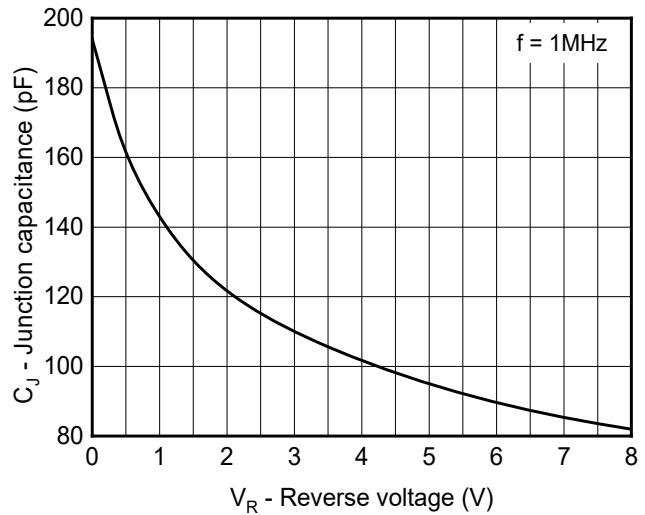
Contact discharge current waveform per IEC61000-4-2



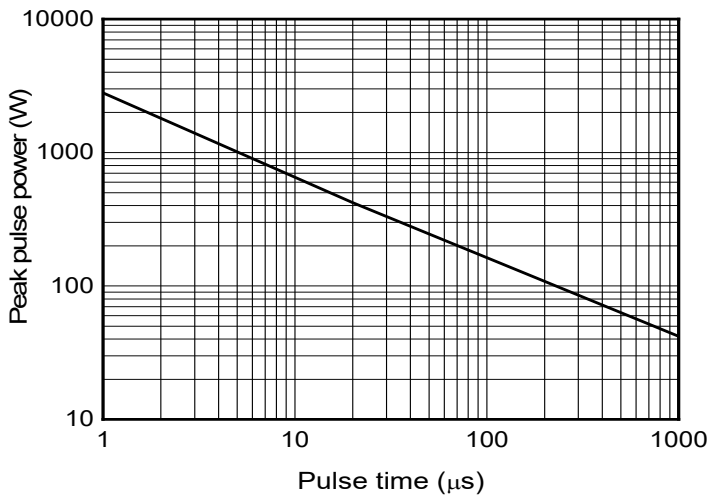
Clamping voltage vs. Peak pulse current



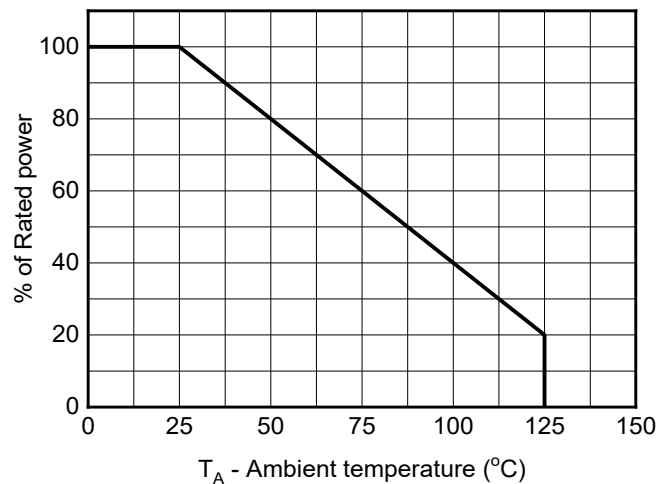
Capacitance vs. Reverse voltage



Non-repetitive peak pulse power vs. Pulse time



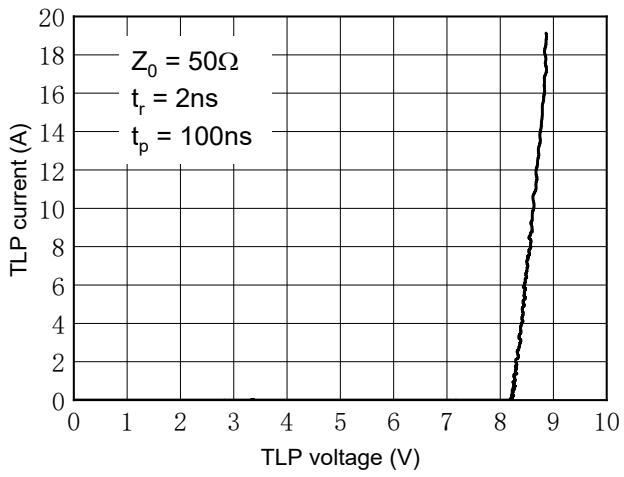
Power derating vs. Ambient temperature





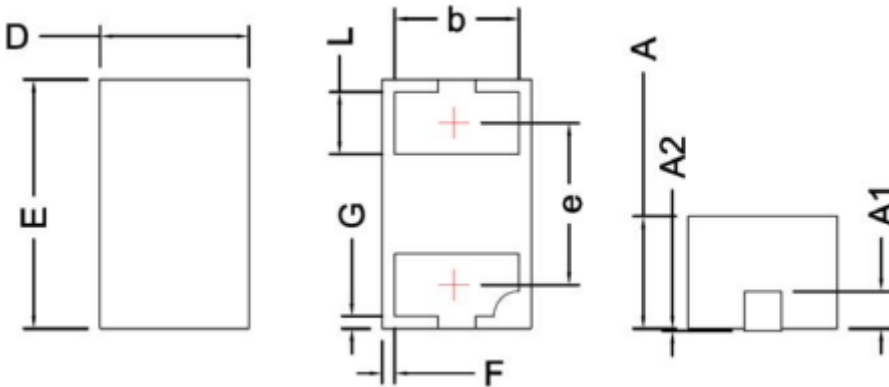
ESD8V0LA2

TLP Measurement



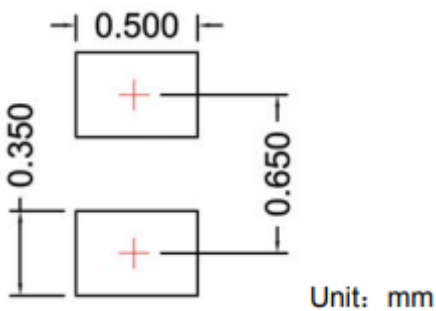


■ Outline Dimensions



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
D	0.50	0.60	0.70
E	0.90	1.00	1.10
A	0.35	0.45	0.55
A1	0.15 BSC		
A2			0.10
F	0.005		
G	0.005		
L	0.15	0.25	0.35
b	0.41	0.50	0.59
e	0.65 BSC		

■ Soldering Footprint



Unit:mm

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met



ESD8V0LA2

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